# DC-DC Converter (-20V, -1.5A)

## RTF015P02

#### Features

- 1) Low on-resistance. ( $80m\Omega$  at 2.5V)
- 2) High power package.
- 3) High speed switching.
- 4) Low voltage drive. (2.5V)

#### Applications

DC-DC converter

### 5161

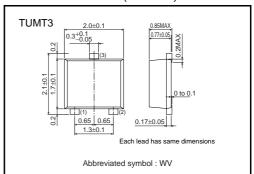
#### ●Structure

Silicon P-channel MOS FET

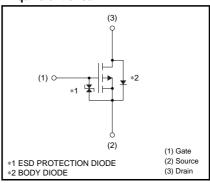
#### Packaging specifications

	Package	Taping		
Type	Code	TR		
	Basic ordering unit (pieces)	3000		
RTF015P02	0			

#### ●External dimensions (Unit : mm)



#### ●Equivalent circuit



#### ●Absolute maximum ratings (Ta=25°C)

Parameter		Symbol	Limits	Unit	
Drain-source voltage		VDSS	-20	V	
Gate-source voltage		Vgss	±12	V	
Drain current	Continuous	lσ	±1.5	Α	
	Pulsed	IDP *1	±6	Α	
Source current	Continuous	Is *1	-0.6	Α	
(Body diode)	Pulsed	Isp	-6	Α	
Total power dissipation		P <sub>D</sub> *2	0.8	W	
Channel temperature		Tch	150	°C	
Range of Storage temperature		Tstg	-55 to +150	°C	

<sup>\*1</sup> Pw≤10μs, Duty cycle≤1% \*2 Mounted on a ceramic board

#### ●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	I <sub>GSS</sub>	-	-	±10	μΑ	V <sub>GS</sub> =±12V, V <sub>DS</sub> =0V
Drain-source breakdown voltage	V <sub>(BR)</sub> DSS	-20	-	_	V	I <sub>D</sub> = -1mA, V <sub>G</sub> S=0V
Zero gate voltage drain current	IDSS	_	_	-1	μΑ	Vps= -20V, Vgs=0V
Gate threshold voltage	VGS (th)	-0.7	_	-2.0	V	Vps= -10V, Ip= -1mA
Static drain-source on-state resistance		_	100	135	mΩ	I <sub>D</sub> = -1.5A, V <sub>G</sub> S= -4.5V
	R <sub>DS (on)</sub>	_	110	150	mΩ	I <sub>D</sub> = -1.5A, V <sub>G</sub> S= -4V
		_	180	250	mΩ	I <sub>D</sub> = -1.5A, V <sub>G</sub> S= -2.5V
Forward transfer admittance	Y <sub>fs</sub> *	1.5	-	_	S	V <sub>DS</sub> = -10V, I <sub>D</sub> = -0.8A
Input capacitance	Ciss	-	560	_	pF	V <sub>DS</sub> = -10V
Output capacitance	Coss	-	90	_	pF	V <sub>GS</sub> =0V
Reverse transfer capacitance	Crss	-	55	_	pF	f=1MHz
Turn-on delay time	<b>t</b> d (on) *	_	12	_	ns	ID= -0.8A
Rise time	tr *	_	12	_	ns	V <sub>DD</sub> ≒ −15V
Turn-off delay time	t <sub>d (off)</sub> *	-	38	_	ns	V <sub>GS</sub> = -4.5V R <sub>L</sub> =9Ω
Fall time	t <sub>f</sub> *	_	12	_	ns	R <sub>G</sub> s=10Ω
Total gate charge	Qg	_	5.2	_	nC	V <sub>DD</sub> ≒−15V RL≒10Ω
Gate-source charge	Qgs	_	1.3	_	nC	$V_{GS} = -4.5V$ RGS=10 $\Omega$
Gate-drain charge	Q <sub>gd</sub>	_	1.4	_	nC	I <sub>D</sub> = -1.5A

\*Pulsed

Body diode characteristics (source-drain characteristics)

Body diode characteristics (Source drain characteristics)						
Forward voltage	VSD	_	_	-1.2	V	I <sub>S</sub> = -0.6A, V <sub>GS</sub> =0V



#### Electrical characteristic curves

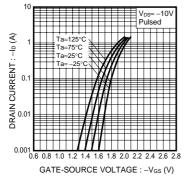


Fig.1 Typical Transfer Characteristics

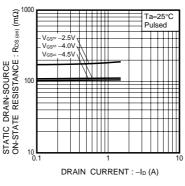


Fig.2 Static Drain-Source On-State Resistance vs. Drain Current

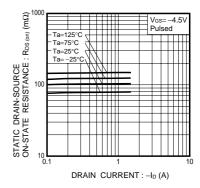


Fig.3 Static Drain-Source On-State Resistance vs. Drain Current

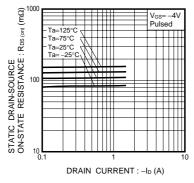


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current

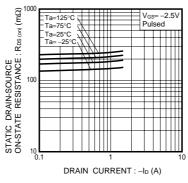


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current

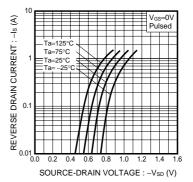


Fig.6 Reverse Drain Current vs. Source-Drain Voltage

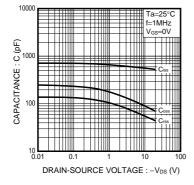


Fig.7 Typical Capacitance vs. Drain-Source Voltage

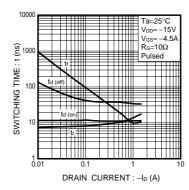


Fig.8 Switching Characteristics

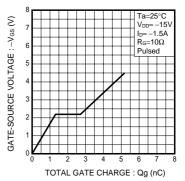


Fig.9 Dynamic Input Characteristics

#### ●Measurement circuits

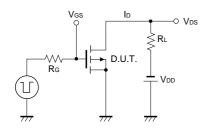


Fig.10 Switching Time Measurement Circuit

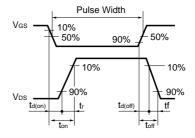


Fig.11 Switching Waveforms

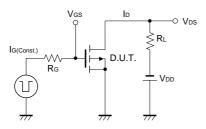


Fig.12 Gate Charge Measurement Circuit

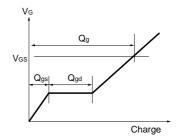


Fig.13 Gate Charge Waveforms

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